

# Product/Process Change (PCN) Notification

PCN Number: CO-21980	Contact: Elizabeth La Greca
Date Issued: Oct 25 <sup>th</sup> , 2018	Title: Director, Sales Operations
PCN Effective Date: Jan 25 <sup>th</sup> , 2019	Phone: 858-255-7839
Product(s) Affected: PE44820	Email: PCN@psemi.com
Sample Availability: Oct 25 <sup>th</sup> , 2018	
Change Control Board Approval #: CO-21980	
Changes Cotogony	
Change Category:	
Change Category:	Shipping/Labeling
	Shipping/Labeling Equipment
Wafer Fabrication Process - Dual Source	
Wafer Fabrication Process - Dual Source	Equipment
Wafer Fabrication Process - Dual Source Design/Mask Change Singulation Process	Equipment Material

### Purpose of Change:

To enable MagnaChip and Lapis as dual source wafer fabrication sites

### **Description of Change:**

MagnaChip closed their 150 mm wafer CMOS fab in South Korea at the end of 2015. To ensure there is no disruption to supply, we have been working to transfer products from MagnaChip fab to Lapis fab in Japan. Beginning Jan 26<sup>th</sup>, 2019, the PE44820 shipped to customers will be supplied from either MagnaChip or Lapis wafers. There is no form, fit and function change.

Ordering codes:

MagnaChip part number: PE44820A-X, EK44820-01 Lapis part number: PE44820B-X, EK44820-02

pSemi manages inventory on a First-In First-Out (FIFO) basis. For the exact timing of the order code change, please contact your account rep. or <u>accountrep@psemi.com</u>.

For more information, please contact PCN@psemi.com.

#### Customer Acknowledgement of Receipt\*:

Change Denied (Include explanation in	Name:	
comments section below)	Title:	
Change Approved	Company:	

\*Customer Acknowledgement is based upon JEDEC Standard, JESD46D. Form # DOC-00558 Rev 2 If there is a difference between JEDEC and specific customer requirements, customer requirements take precedence.



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	Date:	
	Signature:	
Customer Comments:		